

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT3271421

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HIROSHI KITAGAWA	03/12/2015
KOHEI KUSADA	03/16/2015
KATSUTOSHI NAGAOKA	02/24/2015
KATSUTOSHI SATO	02/24/2015
MD. SHAHAJAHAN KUTUBI	02/24/2015
RECEIVING PARTY DATA	
Name:	JAPAN SCIENCE AND TECHNOLOGY AGENCY
Street Address:	1-8, HONCHO 4-CHOME, KAWAGUCHI-SHI
City:	SAITAMA
State/Country:	JAPAN
Postal Code:	332-0012
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14429255
CORRESPONDENCE DATA	
Fax Number:	(202)955-3751
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	RADER FISHMAN & GRAUER PLLC
Address Line 1:	1233 20TH STREET N.W., SUITE 501
Address Line 4:	WASHINGTON, D.C. 20036
ATTORNEY DOCKET NUMBER:	SIF-0003
NAME OF SUBMITTER:	MICHAEL P. SANTONOCITO
SIGNATURE:	/Michael P. Santonocito/
DATE SIGNED:	03/18/2015
Total Attachments: 4	
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ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

CATALYST USING Pd-Ru SOLID SOLUTION ALLOY FINE PARTICLES

For which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Japan Science and Technology Agency, a Japanese corporation with offices at 1-8, Honcho 4-chome, Kawaguchi-shi, Saitama 332-0012 JAPAN, (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of Ten Dollars (\$10.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial Number: 14/429,255 , Filing Date: 03/18/2015 .

This assignment executed on the dates indicated below.

Hiroshi KITAGAWA 北川 宏 12/March/2015
Signature Date

Kohei KUSADA 草田 康平 16/March/2015
Signature Date

Katsutoshi NAGAOKA
Signature Date

Katsutoshi SATO
Signature Date

Md. Shahajahan KUTUBI
Signature Date

ASSIGNMENT

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NOW THEREFORE, in consideration of the sum of Ten Dollars (\$10.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

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Serial Number: 14/429,255 , Filing Date: 03/18/2015 .

This assignment executed on the dates indicated below.

Hiroshi KITAGAWA

Signature

Date

Kohei KUSADA

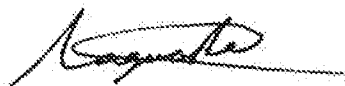
Signature

Date

Katsutoshi NAGAOKA

Signature

Date

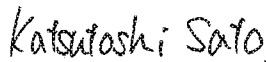


2/24/2015

Katsutoshi SATO

Signature

Date

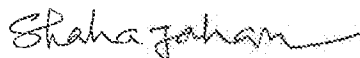


2/24/2015

Md. Shahajahan KUTUBI

Signature

Date



2/24/2015